

Title (en)

METHOD FOR APPLYING A METAL COATING TO A SUBSTRATE, AND PRODUCT OBTAINED

Publication

EP 0272527 A3 19891025 (FR)

Application

EP 87118062 A 19871207

Priority

CH 497886 A 19861215

Abstract (en)

[origin: EP0272527A2] A metallising material is sprayed onto a support with the aid of an arc plasma, under vacuum or gas protection, in order to create a metallising coat of layered structure anchored mechanically to the support. Melting of at least a part of this metallising coat of layered structure is then produced in order to give it a crystalline structure in its melted part.

IPC 1-7

C23C 4/18; **C23C 4/12**

IPC 8 full level

C23C 4/12 (2006.01); **C23C 4/18** (2006.01)

CPC (source: EP)

C23C 4/134 (2016.01); **C23C 4/18** (2013.01)

Citation (search report)

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